

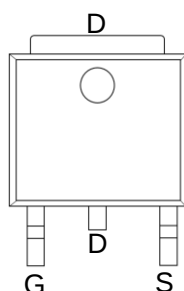
-100V/-15A P-Channel MOSFET

Features

- Split gate trench MOSFET technology
- Low $R_{DS(on)}$ & FOM
- Extremely low switching loss
- Excellent stability and uniformity

Application

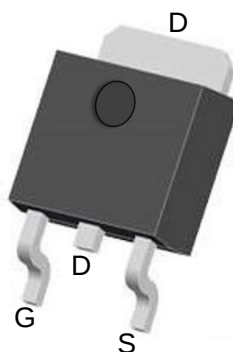
- Power management
- Portable equipment



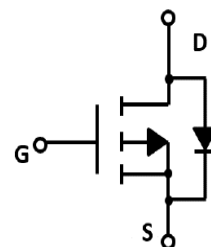
Marking and pin assignment

Product Summary

V_{DS}	$R_{DS(on)}$ MAX	I_D MAX
-100V	170mΩ@-10V	-15A
	210mΩ@-4.5V	



TO-252 top view



Schematic diagram



Pb-Free



RoHS



Halogen-Free

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
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Common Ratings (TC=25°C Unless Otherwise Noted)

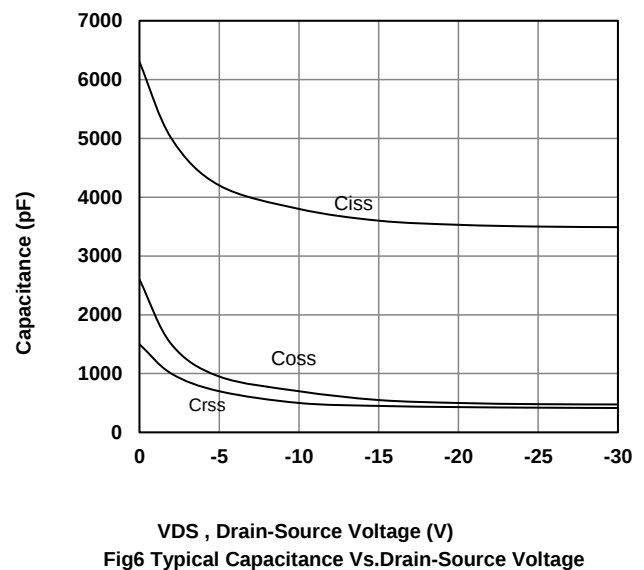
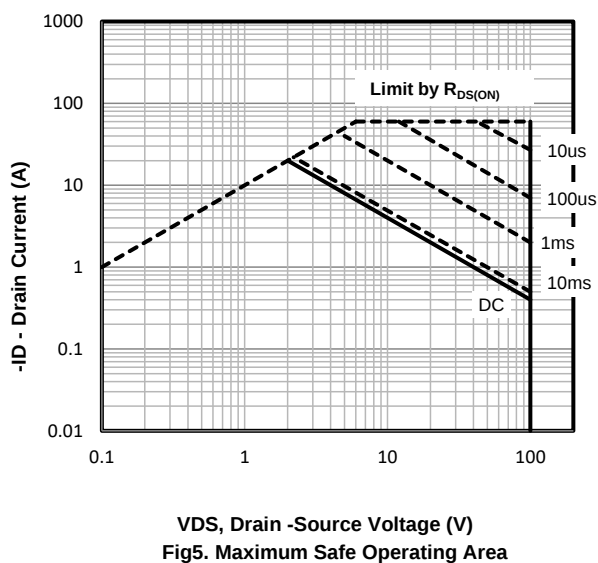
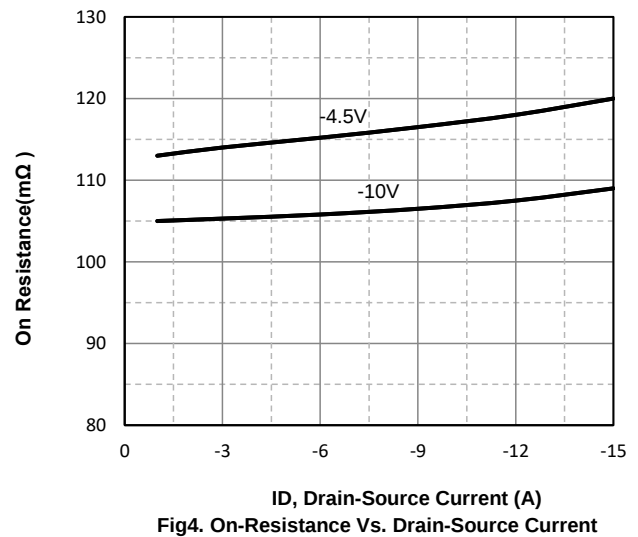
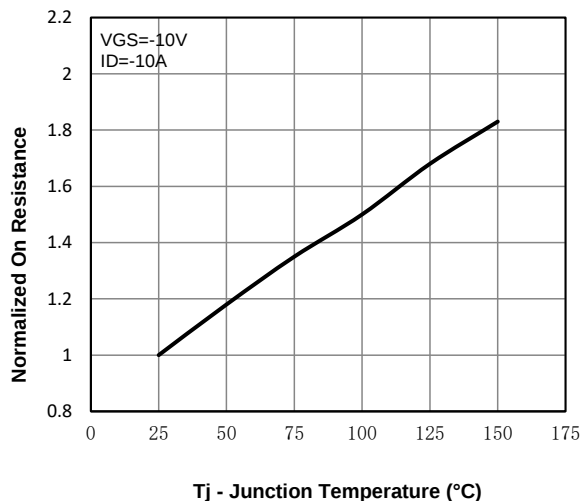
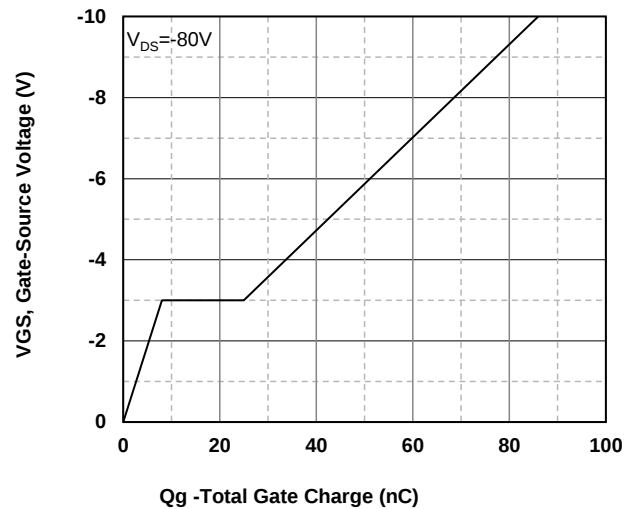
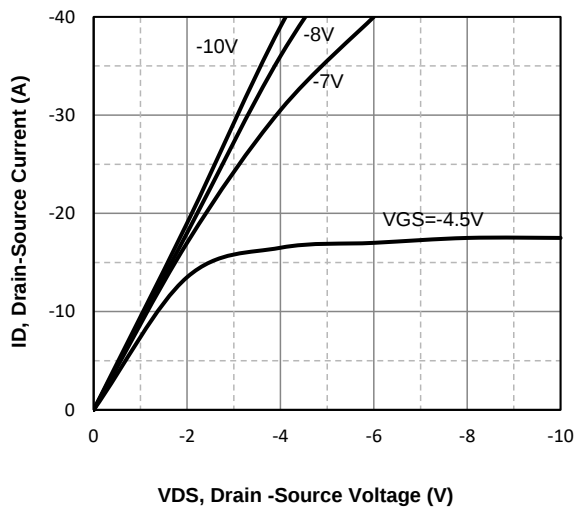
V_{DS}	Drain-Source Breakdown Voltage	-100	V
V_{GS}	Gate-Source Voltage	±20	V
T_J	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	-50 to 155	°C
I_S	Diode Continuous Forward Current	$T_c=25^\circ\text{C}$ -15	A

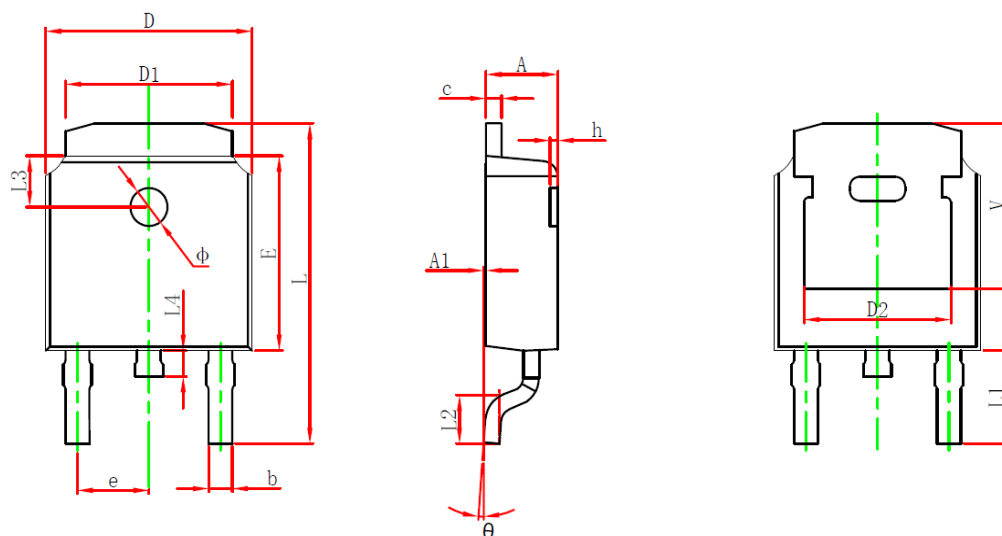
Mounted on Large Heat Sink

I_{DM}	Pulse Drain Current Tested	$T_c=25^\circ\text{C}$ -60	A
I_D	Continuous Drain Current@GS=10V	$T_c=25^\circ\text{C}$ -15	A
P_D	Maximum Power Dissipation	$T_c=25^\circ\text{C}$ 72	W
EAS	Single Pulsed Avalanche Energy	72	mJ

Electrical Characteristics (TJ=25℃ unless otherwise noted)						
Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ TJ = 25℃ (unless otherwise stated)						
BV _{(BR)DSS}	Drain-Source Breakdown Voltage	VGS=0V, ID=-250μA	-100	--	--	V
IDSS	Zero Gate Voltage Drain Current	VDS=-100V, VGS=0V	--	--	-1.0	uA
IGSS	Gate-Body Leakage Current	VGS=±20V, VDS=0V	--	--	±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS, ID=-250μA	-1.0	-1.8	-3.0	V
RDS(on)	Drain-Source On-State Resistance	VGS=-10V, ID=-10A	--	105	170	mΩ
		VGS=-4.5V, ID=-5A	--	120	210	mΩ
Dynamic Electrical Characteristics @ TJ = 25℃ (unless otherwise stated)						
CISS	Input Capacitance	VDS=-25V, VGS=0V, f=1MHz	--	3500	--	pF
COSS	Output Capacitance		--	480	--	pF
CRSS	Reverse Transfer Capacitance		--	340	--	pF
Switching Characteristics						
Qg	Total Gate Charge	VDS=-80V, ID=-10A, VGS=-10V	--	85	--	nC
Qgs	Gate Source Charge		--	7	--	nC
Qgd	Gate Drain Charge		--	18	--	nC
t _{d(on)}	Turn-on Delay Time	VDS=-25V, ID=-10A, VGS=-10V, RG=3Ω	--	13	--	nS
t _r	Turn-on Rise Time		--	20	--	nS
t _{d(off)}	Turn-Off Delay Time		--	22	--	nS
t _f	Turn-Off Fall Time		--	11	--	nS
Source- Drain Diode Characteristics						
VSD	Forward on voltage	Tj=25℃, Is=-10A,	--	-0.8	-1.2	V

Typical Operating Characteristics



TO-252 Package information


Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.635	0.770	0.025	0.030
c	0.450	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 REF.		0.190 REF.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.712	10.312	0.386	0.406
L1	2.900 REF.		0.114 REF.	
L2	1.400	1.700	0.055	0.067
L3	1.600 REF.		0.063 REF.	
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.250 REF.		0.207 REF.	